

Special Issue

Piezoelectric Transducers: Materials, Devices and Applications, Volume II

Message from the Guest Editor

Advances in miniaturization of sensors, actuators, and smart systems are receiving substantial industrial attention, and a wide variety of transducers are commercially available or have high potential to impact emerging markets. Substituting existing products based on bulk materials, in fields such as automotive, environment, food, robotics, medicine, biotechnology, communications, and other technologies, with reduced size, lower cost, and higher performance, is now possible, with potential for manufacturing using advanced silicon integrated circuit technology or alternative additive techniques from the mili- to the nano-scale.

Deadline for manuscript submissions

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